Product Specification

108-60036

AMP Connector

AMPLIMITE* .050 Series I, Board to Board Lead Free Version

1. Scope:

1.1 Contents

This specification covers the requirements for product performance, test methods and quality assurance provisions of AMPLIMITE* .050 Series I, Board-to-Board Connector of the following part numbers.

Prod	uct No	Pro	Product Descriptions		Mounting Type	Remar	xs		
X-51	73277-X	Но	orizontal Plug Ass'	у	Screw-on				
X-51	73278-X	Нс	orizontal Cap Ass'	у	Screw-on				
X-51	73279-X	Ve	ertical Plug Ass' y	:	Screw-on				
X-51	73280-X	Ve	ertical Cap Ass' y	:	Screw-on				
X-51	74207-X	Но	orizontal Plug Ass'	y]	Retention Leg	g			
X-51	74214-X	Ho	orizontal Cap Ass'	y]	Free Standing	5			
X-51	74215-X	Ve	ertical Plug Ass' y]	Free Standing	5			
X-51	74216-X	Ve	ertical Cap Ass' y	1	Free Standing	5			
X-51	74217-X	Нс	orizontal Plug Ass'	y]	Retention Lea	g			
X-51	74218-X	Нс	orizontal Cap Ass'	y]	Retention Lea	g			
X-51	74681-X	Ve	ertical Plug Ass' y	,	w/Kink				
X-51	74682-X	Ho	orizontal Plug Ass'	у	w/Kink				
X-51	74683-X	Ve	ertical Cap Ass' y	,	w/Kink				
X-51	74684-X	Но	orizontal Cap Ass'	у	w/Kink				
X-51	75710-X	Ve	ertical Plug Ass' y	,	w/Kink				
X-51	75711-X	Ve	ertical Cap Ass' y	,	w/Kink				
X-51	78857-X	Ve	ertical Cap Ass' y	,	w/Kink	w/Pola	rity Post (L, C	, P)	
X-51	79359-X	Ve	ertical Cap Ass' y	,	w/Kink	Side C	ut Type		
			DR						
			C. WA	ANG	_ tyc	:0	Tyco Elect		
			СНК S. YA	0	Electro	onics	AMP Shang	hai Lt	d
			APP I. ENO	ОМОТО	NO 108-	60036		REV O	LOC ES
			PAGE	TITLE					
RELEASED FB00-026	8-04 C.W	20AUG	1 of 7	AMP Co	nnector, Am	plimite*.05	50 Series I B7	B	
REVISION RECORD		DATE	1 01 /	Connecto	or Lead Fre	e Version			

0

LTR

DIS'

THIS INFORMATION IS CONFIDENTIAL AND IS DISCLOSED TO YOU CONDITION THAT NO FURTHERE DISCLOSURE IS MADE BY YOU ON COTHER THAN AMP PERSONNEL WITHOUT WRITTEN AUTHORIZATION FROM AMP SHANGHAI LTD

The difference of the thickness of gold-plating is classified by the prefix number, and the contact position is so with

the suffix numbers.

Fig. 1

2. Type of the Products:

The type of the products and their state of application are shown below.



3. Applicable Documents:

The following documents form a part of this specification to the extent specified here in. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

3.1 AMP Specifications:

A. 109-1 Test Specification, General Requirements for Test Methods

3.2 Military Standard and Specifications:

MIL-STD-202 Test Methods for Electronic and Electrical Component Parts

3.3 501-60015 : Product Qualification Test Report

4. Requirements:

4.1 Structure, Shape and Dimension

The product structure, shape and dimensions shall conform to requirements shown on applicable drawing, unless other wise specified below.

(1) Number of Positions : • 9 type in 20,30,34,40,48,50,60,68 and 96 positions

(2)	Connector Type:	• Horizontal
		• Vertical
(3)	Pitch and Row:	• Engaging Side: 1.27 mm pitch x2.54 mm in 2 rows
		• Board Side: 2.54 mm pitch x1.905 mm in zigzag of 4
		rows
(4)	Mounting on PCB:	° Screw-on (M2 Screws) Type
		• Free Standing Type
		• Retention Leg Type
		• With Kink Type
(5)	Applicable DCD.	Doord Thickness, 0.9.1.6 mm with colder resistive egent

(5) Applicable PCB: • Board Thickness: 0.8-1.6 mm with solder resistive agent applied on Solder side.

: The kink Type is 1.6 mm Thk only.

tyco	Tyco Electronics	PAGE	NO	REV	LOC
Electronics	AMP Shanghai Ltd	3	108-60036	0	ES

4.2 Material and Finish:

4.2.1 Receptacle Contact and post Contact:

- (1) Material: Phosphor Bronze
- (2) Finish: Underplating:1.3 µm min. Nickel Underplate all over

	\circ Gold-Plating0.2 μ m min. thick gold plated
	for 0-prefix
	(Contact Area) no. items, and 0.75 μ m min.
	thick for 6-prefix no.items.
	 Other Areas: Gold Flash Plated
	 Tine Soldering: 1.0 μm min. Tin-plated
	4.2.2 Housing:
	(1) Material : Fider Glass reinforced
	polybuthyleneterephalate resin (P. B. T.)
	Colour: Black
	178854 & 178857: Liquid Crystal Polymer
	Colour: Black
	(2) Flame Retardancy UL 94 V –0
	4.2.3 Retention Leg :
	(1) Material: Brass
	(2) Finish : $\circ 1.0 \mu m$ min. thick nickel underplate all over
	\circ 2.0 μ m min. thick tin plating all over
4.3	Appearance:
	The connectors shall be free from the defects such as damage. Cracks, deformation, blister, dirt and burrs that are detrimental to connector functions and product merchandising value.

4.4 Ratings:

- (1) Temperature Rating: -55°C/+105°C
- (2) Current Rating: 1 A max.
- (3) Voltage Rating: 100V DC. Max.

tyco Tyco ElectronicsElectronicsAMP Shanghai Ltd	PAGE NO	108-60036	REV O	LOC ES
---	---------	-----------	----------	-----------

4.5 Performance and Test Descriptions:

The product is designed to meet the electrical, mechanical and environmental performance requirements specified in Fig. 5. All tests are performed at ambient temperature unless otherwise specified.

Para.	Test Items	Requirements			Procedures
4.6.1	Confirmation of Product	Product shall be conforming to the requirements of applicable product drawing.			Visually, dimensionally and functionally inspected per applicable inspection plan.
Electri	ical Requirements				
	Termination Resistance (Low Level)	Timing Combination	Initial Max.	After Test Max.	Subject mated contacts assembled in housing to closed circuit current of 10
4.6.2		Horizontal-to- horizontal	25mΩ	50mΩ	mA max. at open circuit voltage of 50 mV max. Fig. 6.
		Horizontal-to- vertical			
		Vertical-to-vertical	$15 \text{m}\Omega$	30mΩ	
4.6.3	Insulation Resistance	1000 MΩ min. (Initi 500 MΩ min. (Final)			Measure by applying test potential between the adjacent contacts, and between the contacts and ground in the mated connector.
					MIL-STD-202, Method 302,
					Condition B
4.6.4	Dielectric Strength	No abnormalities such break-down or flash place during the test.	over shal		Measure by applying test potential between the adjacent contacts. In the mated connectors.
					MIL-STD-202, Method 301

4.6 Test Requirements and Procedures Summary:

tyco	Tyco Electronics	PAGE	NO	REV	LOC
Electronics	AMP Shanghai Ltd	5	108-60036	0	ES

UCO lectronics	_		o Electronics ⁹ Shanghai Ltd	PAGE 6	NO	108-60036		REV O	L(I
			Fig.	5 (to be	e continue	ed)			
						Calculate va		contac	t.
	Unmat	ing Force	per contact			the force req connectors b 100 mm a m	y operat		;
4.6.9	Connec		0.20N min.			Using autogr	-		
4.6.8	Connec Mating		0.78N max. per contact			Using autogra the force req connectors b 100 mm a m using autogr the value for	uired to by operat inute. R aph. Cal	mate ing at ecord b culate	У
4.6.9		- 1 - 1	0.70N			Condition A			
						MIL-STD-20	02, Metł	10d 213	1
4.6.7	Physica	al Shock	No electrical discontinuity greater than 1 microsecond (s) shall occur.				k pulses ration; tion nutually	s 3 y	
						Condition A			
						MIL-STD-20	-		-
4.6.6	Vibrati Sinuso Freque	idal High	No electrical discon than 1 microsecond		-	Subject mate 10-500-10 H minutes with accelerated v each of 3 mu perpendicula	Iz travers 1 10 G velocity; 1tually	sed in 1 2 hours	5
Physica	ıl Requir	ements							
	Curren		current.			Fig. 6	current	•	
4.6.5	Tempe Rising		30°C max. Under lo current.	aded sp	ecified	Measure terr by energized	-	•	
Para.	Test Ite	ems	Requirements			Procedures			

Para.	Test Items	Require			Procedures		_
4.6.10	Durability (Repeated Mate/Unmating)	The requirements sp 4.6.8 and 4.6.9 shall test.		Mate and unmate con for 100 cycles in the method of testing as Specified in Para 4.6	same		
4.6.11	Resistance to Soldering Heat	No physical damage after the test.	e shall t	be evident	Subject product more printed circuit bo solder bath at 260±5 seconds	ards t	to
		Environmenta	l Requi	rements	1		
4.6.12	Thermal Shock	The requirement sp 4.6.2 shall be met af	-		Subject mated/Un connectors to 5 c between -55°C and MIL-STD-202, Met Condition A	ycles +85°C hod 107	
4.6.13	Humidity- Temperature Cycling	The requirement specified in Para. 4.6.2 shall be met after the test.			Subject mated conne 10 cycles of humidity temperature changes between 25°C and 65 95 % R.H.	у-	,
					MIL-STD-202, Meth with cold shock as -1		
4.6.14	Temperature Life	The requirement sp 4.6.2 shall be me			Subject mated conne temperature life; 85± 250 Hours, MIL-STD-202, Meth Condition B	-2°C,	
4.6.15	SO2 Gas	The requirement sp 4.6.2 shall be me	-		Engage connectors, a expose to SO2 on for conditions. SO2 Concentration: ppm Relative Humidity: 9 min. Temperature : Roo temperature Time : 48 hour	llowing 10±3 00% m	. ,
			Fig.5 (6	end)			
Electronics		eo Electronics 9 Shanghai Ltd	PAGE 7	NO	108-60036	REV O	L

3.7 Product Qualification and Requalification Tests.

				Tes	t Grou	ıp (a)			
Test of Examination	1	2	3	4	5	6(c)	7	8	9
Examination of Product	1,7	1,5	1,5	1,5	1,5	1,6	1,7	1,3	1,3
Termination Resistance,	4,6	2,4	2,4	2,4	2,4	2,5			
Dry Circuit									
Dielectric Withstanding							3,6		
Voltage									
Insulation Resistance							2,5		
Temperature Rise vs.								2	
Current									
Vibration						3			
Physical Shock						4			
Mating Force	2								
Unmating Force	3								
Durability	5								
Resistance to Soldering									2
Heat									
Thermal Shock (per			3						
Product Spec)									
Humidity-Temperature		3					4		
Cycling									
SO2 Gas					3				
Temperature Life				3					

(a) See Para 4.1.A.

(b) Numbers indicate sequence in which tests are performed.

(c) Discontinuities shall not take place in this test group. During tests.

Fig. 6

tyco	Tyco Electronics	PAGE	NO	REV	LOC
Electronics	AMP Shanghai Ltd	8	108-60036	O	ES

5. QUALITY ASSURANCE PROVISIONS

5.1 Test Conditions:

All the tests shall be performed under any combination of the following test conditions.

Temperature	: 15~35°C
Relative Humidity	: 45-75%
Atmospheric Pressure	: 86.7~106.7kPa

5.2 The test specimens to be employed for the tests, shall be conforming to the applicable product drawing(s).

Fig. 7 shows the low-level termination resistance and temperature rising measuring points. This drawing applies to horizontal type to horizontal type combination. But horizontal type to vertical type and vertical type to vertical type configurations shall also have their termination resistance measured between tines after installation on circuit boards.



Fig. 7

tyco	Tyco Electronics AMP Shanghai Ltd	PAGE		REV	LOC
Electronics		9	108-60036	0	ES